

(Reference)	(Test Item)	(Condition)	(Sample size)	(Decision)	
5PCS (FG)	LSL≤Electrical Parameter≤USL	IEC 60747-1 (High Temperature Reverse Bias)	1	b. Time: 168h/1000h; Temperature: Fast Recovery Diode or Thyristor: 125°C; Discrete Device, MOSFET or IGBT: 145°C; Rectifier Diode: 175°C.	
5PCS (FG)	LSL≤Electrical Parameter≤USL	IEC 60747-1 (High Temperature Grating Bias)	2	168h/1000h.	
Temperature: Low Temperature -55°C for 30min; High Temperature 150°C for 30min; Transition Time: 10s; Times: 10Times/100Times.	5PCS (FG)	LSL≤Electrical Parameter≤USL	3	温度循环 (Temperature Cycling)	a. Temperature b. Convection c. Cycle
Temperature: 85°C; Humidity: 85% RH; Times: 168h/1000h.	5PCS (FG)	LSL≤Electrical Parameter≤USL	4	恒温恒湿 (Constant Temperature and Humidity)	a. Temperature b. Humidity c. Time
a. Temperature: Tsignat; b. Time: 168h/1000h.	5PCS (FG)	LSL≤Electrical Parameter≤USL	6	高温存储 (High Temperature Storage)	
a. Max. I: 500; b. Pulse Time: 6ms, Sine Half Wave; c. Dir.: X / Y / Z, 3 Positive and 3 Negative Impacts, 18Times in total.	5PCS (FG)	LSL≤Electrical Parameter≤USL	8	冲击试验 (Shock Test)	
a. Vibration Waveform: 5~200 Hz, Sine Wave; b. Direction of Vibration: X, Y, Z; c. Direction of Vibration: X, Y, Z	5PCS (FG)	LSL≤Electrical Parameter≤USL	10	振动试验 (Vibration Test)	